

LNPT[™] THERMOCOMP[™] COMPOUND OMCOD

DESCRIPTION

LNP THERMOCOMP OMCOD compound is a mineral reinforced polyphenylene sulfide. Added feature of this material include: high dielectric constant, low dissipation factor, good flame and chemical resistance, low moisture absorption.

GENERAL INFORMATION

Features	Flame Retardant, Chemical Resistance, Dielectrics, No PFAS intentionally added
Fillers	Mineral
Polymer Types	Polyphenylene Sulfide, Linear (PPS, Linear)
Processing Techniques	Injection Molding

INDUSTRY

Automotive
Electrical and Electronics

SUB INDUSTRY

Automotive Interiors
Electronic Components, Wireless Communication

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, brk, Type I, 5 mm/min	73	MPa	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	1.2	%	ASTM D638
Tensile Modulus, 5 mm/min	9200	MPa	ASTM D638
Flexural Strength, 1.3 mm/min, 50 mm span	92	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	8800	MPa	ASTM D790
Tensile Stress, break, 5 mm/min	72	MPa	ISO 527
Tensile Strain, break, 5 mm/min	1.2	%	ISO 527
Tensile Modulus, 1 mm/min	9400	MPa	ISO 527
Flexural Strength, 2 mm/min	100	MPa	ISO 178
Flexural Modulus, 2 mm/min	9000	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	38	J/m	ASTM D256
Izod Impact, unnotched, 23°C	280	J/m	ASTM D4812
Izod Impact, notched 80°10°4 +23°C	4	kJ/m ²	ISO 180/1A
Izod Impact, notched 80°10°4 0°C	4	kJ/m ²	ISO 180/1A
Izod Impact, notched 80°10°4 -20°C	3.4	kJ/m ²	ISO 180/1A
Izod Impact, unnotched 80°10°4 +23°C	16.5	kJ/m ²	ISO 180/1U
Izod Impact, unnotched 80°10°4 0°C	16	kJ/m ²	ISO 180/1U
Izod Impact, unnotched 80°10°4 -20°C	14	kJ/m ²	ISO 180/1U
Charpy 23°C, V-notch Edgew 80°10°4 sp=62mm	3	kJ/m ²	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80°10°4 sp=62mm	20	kJ/m ²	ISO 179/1eU
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 3.2 mm, unannealed	220	°C	ASTM D648

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CHEMISTRY THAT MATTERS[™]

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT, 1.82 MPa, 3.2mm, unannealed	195	°C	ASTM D648
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	216	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	205	°C	ISO 75/Af
CTE			
-40°C to 90°C, flow	4.2E-5	1/°C	ASTM E831
-40°C to 90°C, xflow	4.2E-5	1/°C	ASTM E831
-40°C to 40°C, flow	3.4E-5	1/°C	ISO 11359-2
-40°C to 40°C, xflow	3.4E-5	1/°C	ISO 11359-2
-40°C to 90°C, flow	4.2E-5	1/°C	ISO 11359-2
-40°C to 90°C, xflow	4.2E-5	1/°C	ISO 11359-2
-40°C to 125°C, flow	5.1E-5	1/°C	ISO 11359-2
-40°C to 125°C, xflow	5.1E-5	1/°C	ISO 11359-2
PHYSICAL ⁽¹⁾			
Specific Gravity	2.32	-	ASTM D792
Water Absorption, (23°C/24hrs)	0.02	%	ISO 62-1
Moisture Absorption, (23°C/50% RH/24hrs)	0.01	%	ISO 62-4
Melt Flow Rate, 315°C/5.0 kgf	50	g/10 min	ASTM D1238
Mold Shrinkage, flow ⁽²⁾	0.8	%	SABIC method
Mold Shrinkage, xflow ⁽²⁾	0.8	%	SABIC method
ELECTRICAL ⁽¹⁾			
Dielectric Constant, 1.1 GHz	9.4	-	SABIC method
Dissipation Factor, 1.1 GHz	0.0017	-	SABIC method
Dielectric Constant, 1.9 GHz	9.4	-	SABIC method
Dissipation Factor, 1.9 GHz	0.0021	-	SABIC method
Dielectric Constant, 5 GHz	9.3	-	SABIC method
Dissipation Factor, 5 GHz	0.0025	-	SABIC method
INJECTION MOLDING ⁽³⁾			
Drying Temperature	120 – 140	°C	
Drying Time	3 – 4	Hrs	
Melt Temperature	310 – 330	°C	
Nozzle Temperature	310 – 330	°C	
Front - Zone 3 Temperature	310 – 330	°C	
Middle - Zone 2 Temperature	300 – 320	°C	
Rear - Zone 1 Temperature	290 – 310	°C	
Mold Temperature	135 – 160	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	50 – 100	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.



ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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